

Electronic Patent Application Fee Transmittal

Application Number:	10720529			
Filing Date:	25-Nov-2003			
Title of Invention:	DIFFUSION BONDING FOR METALLIC MEMBRANE JOINING WITH METALLIC MODULE			
First Named Inventor/Applicant Name:	Anwu Li			
Filer:	Gerald S. Oyen/MaryAnne Broccolo			
Attorney Docket Number:	M596 0008/GSO			
Filed as Small Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Utility Appl issue fee	2501	1	720	720
Publ. Fee- early, voluntary, or normal	1504	1	300	300

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension-of-Time:				
Miscellaneous:				
Total in USD (\$)				1020